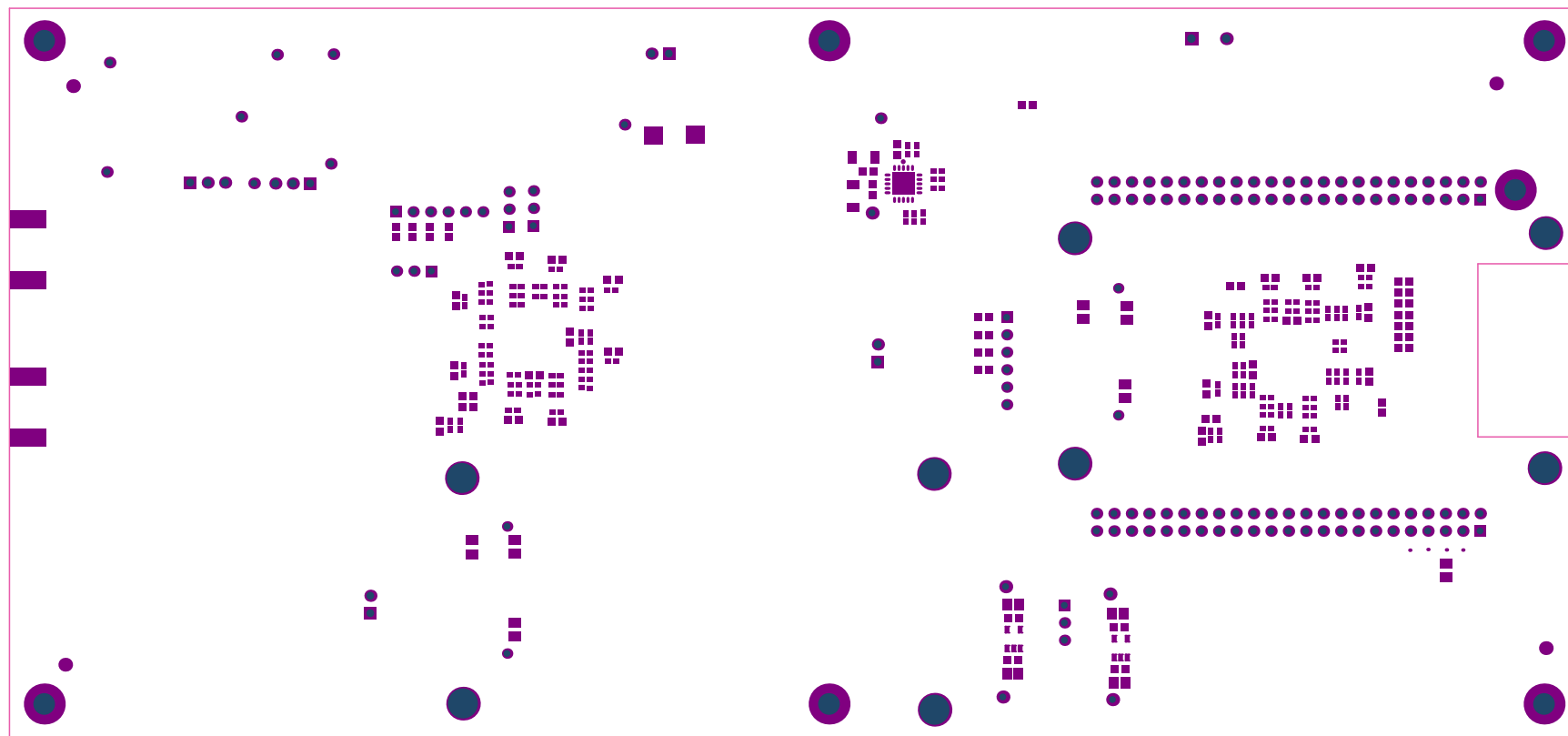
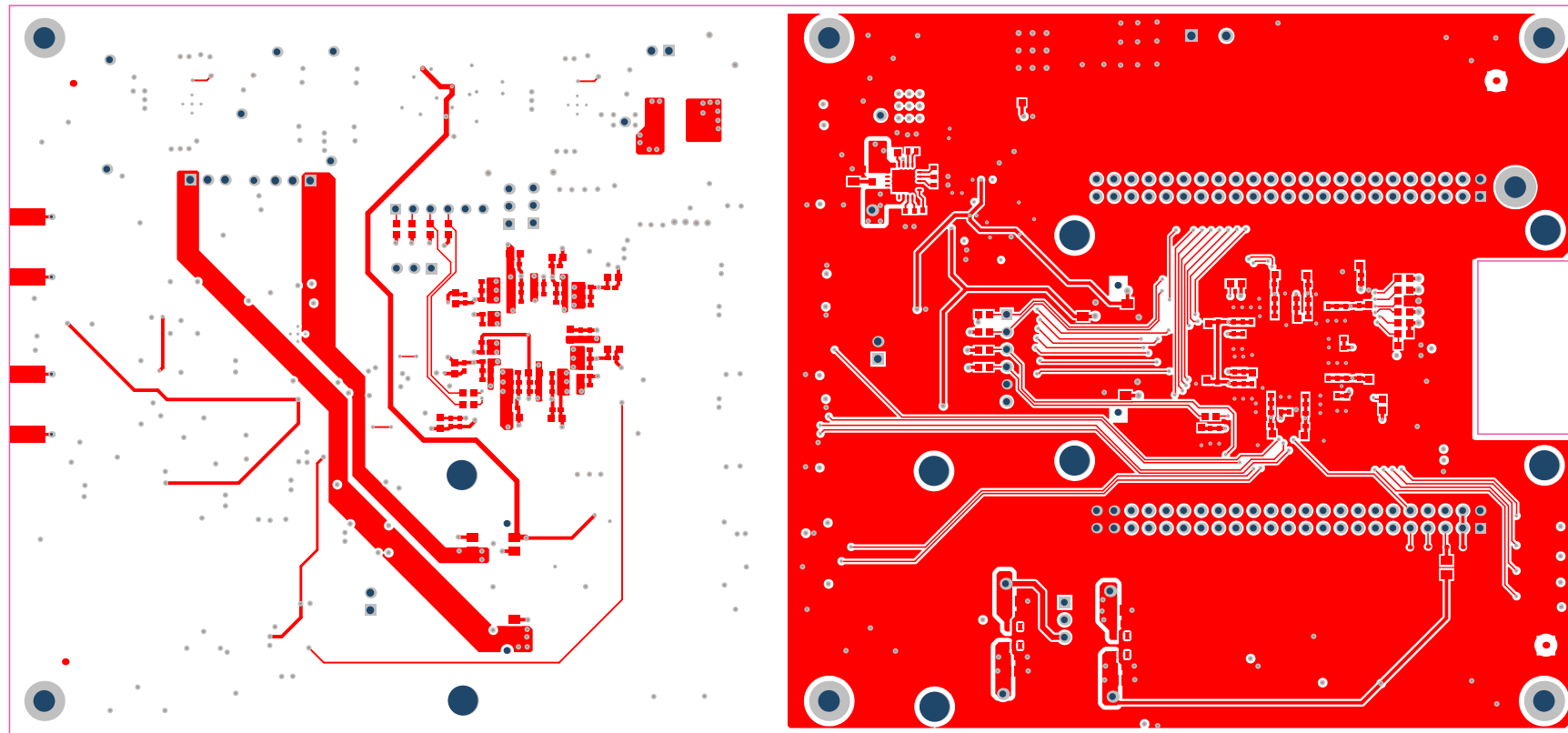


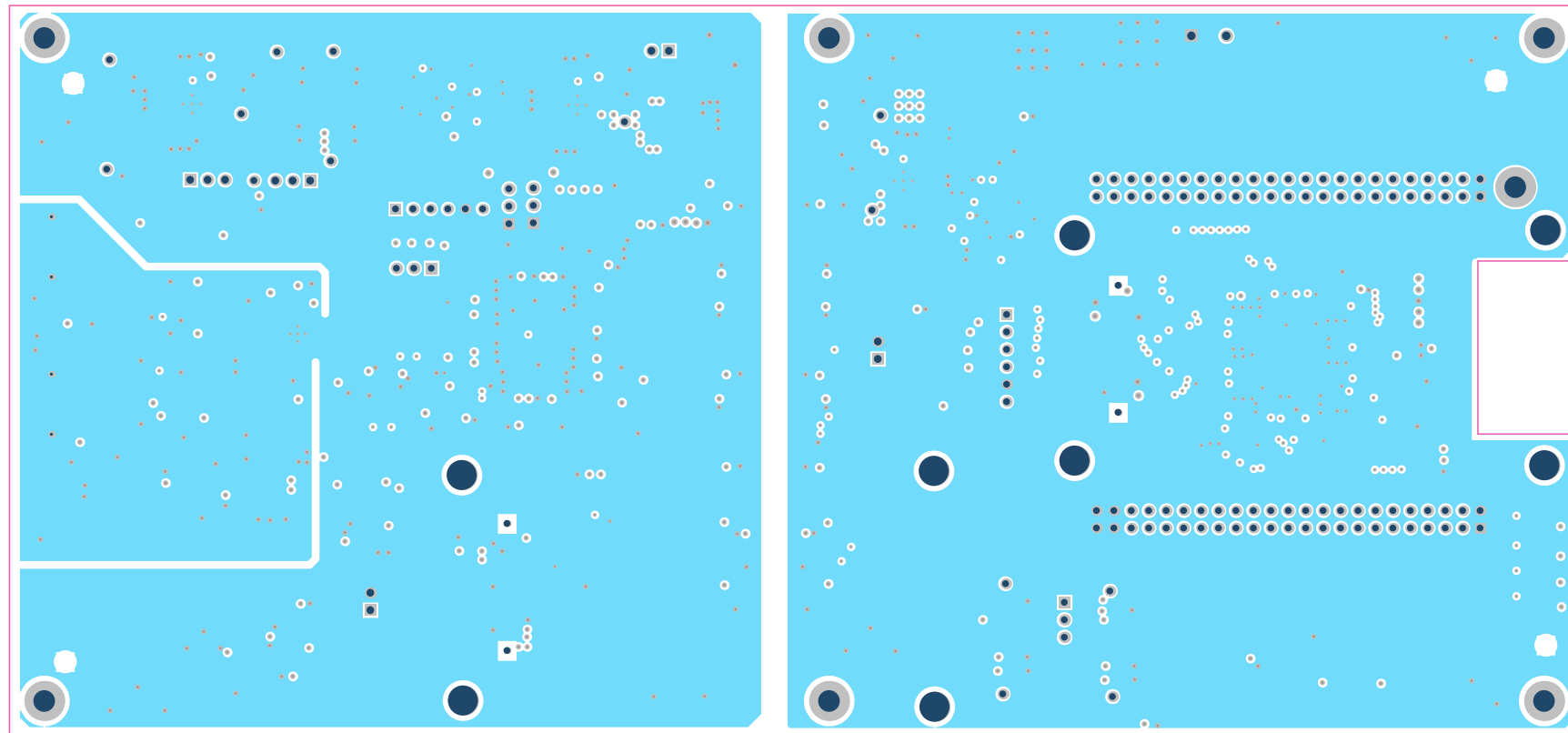
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = TOP PASTE	TID #: TIDA-00732		
PLOT NAME = Top paste	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



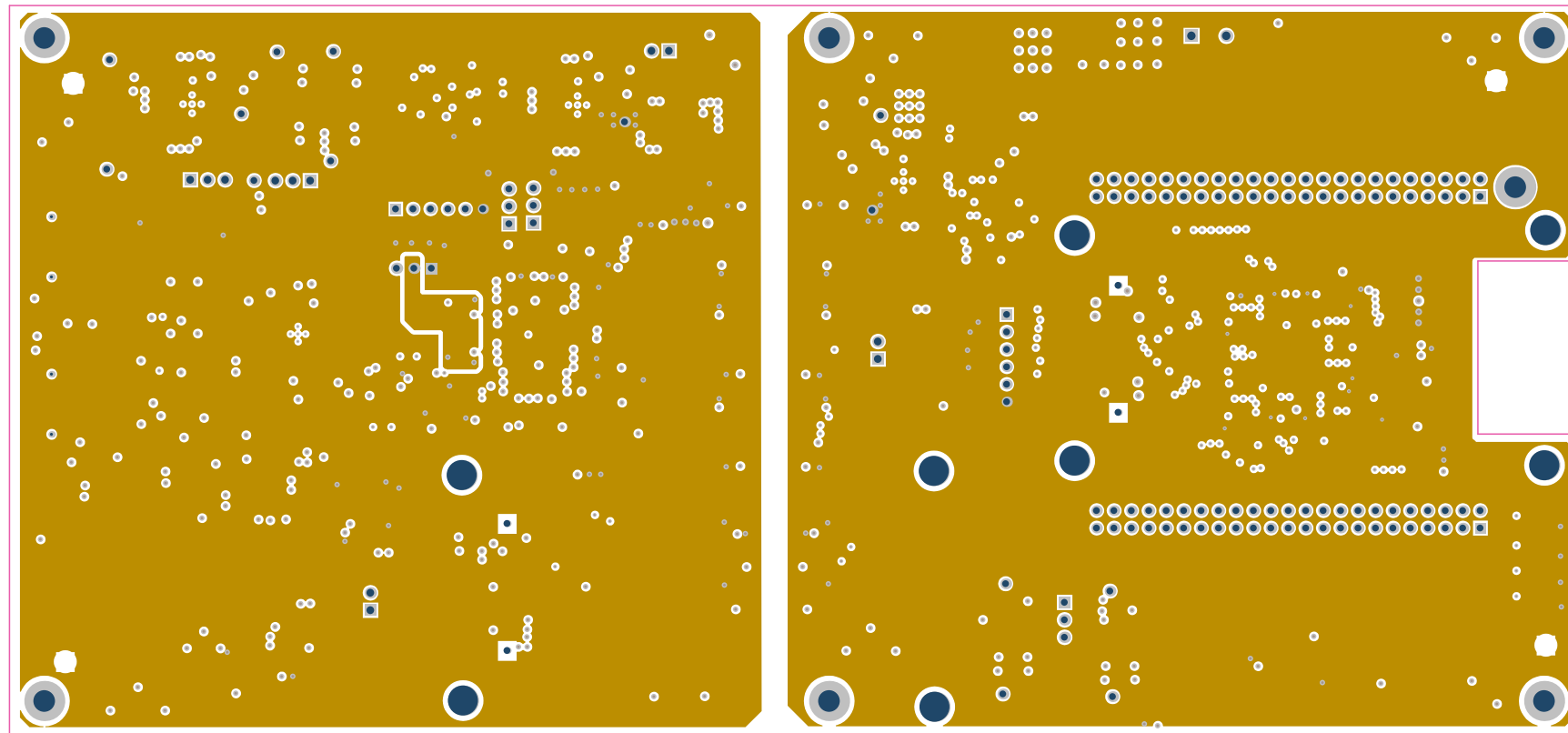
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = TOP SOLDER	TID #: TIDA-00732		
PLOT NAME = Top Solder Mask	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



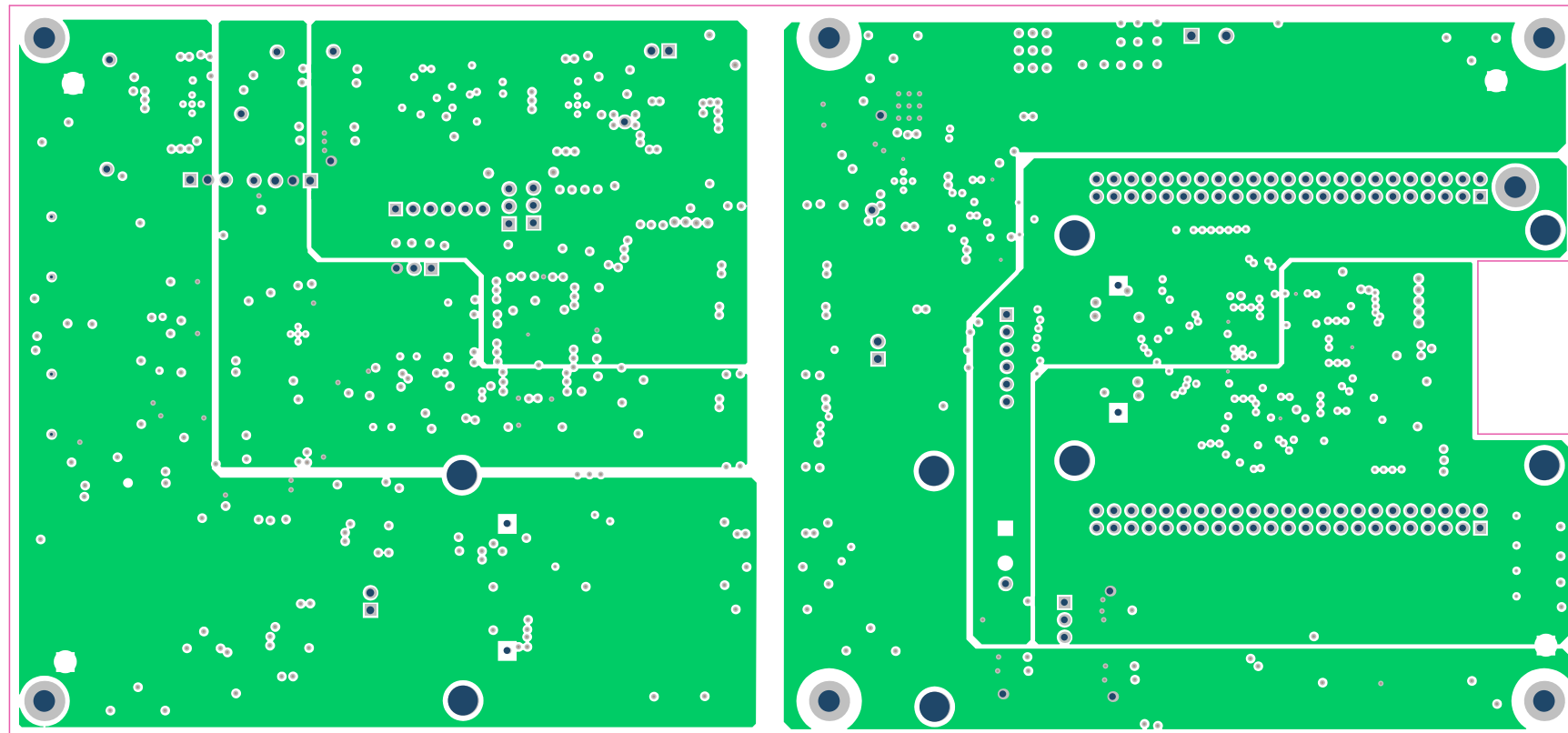
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = TOP LAYER	TID #: TIDA-00732		
PLOT NAME = Top Layer	GENERATED : 02/10/2015 12:12:36 PM		TEXAS INSTRUMENTS



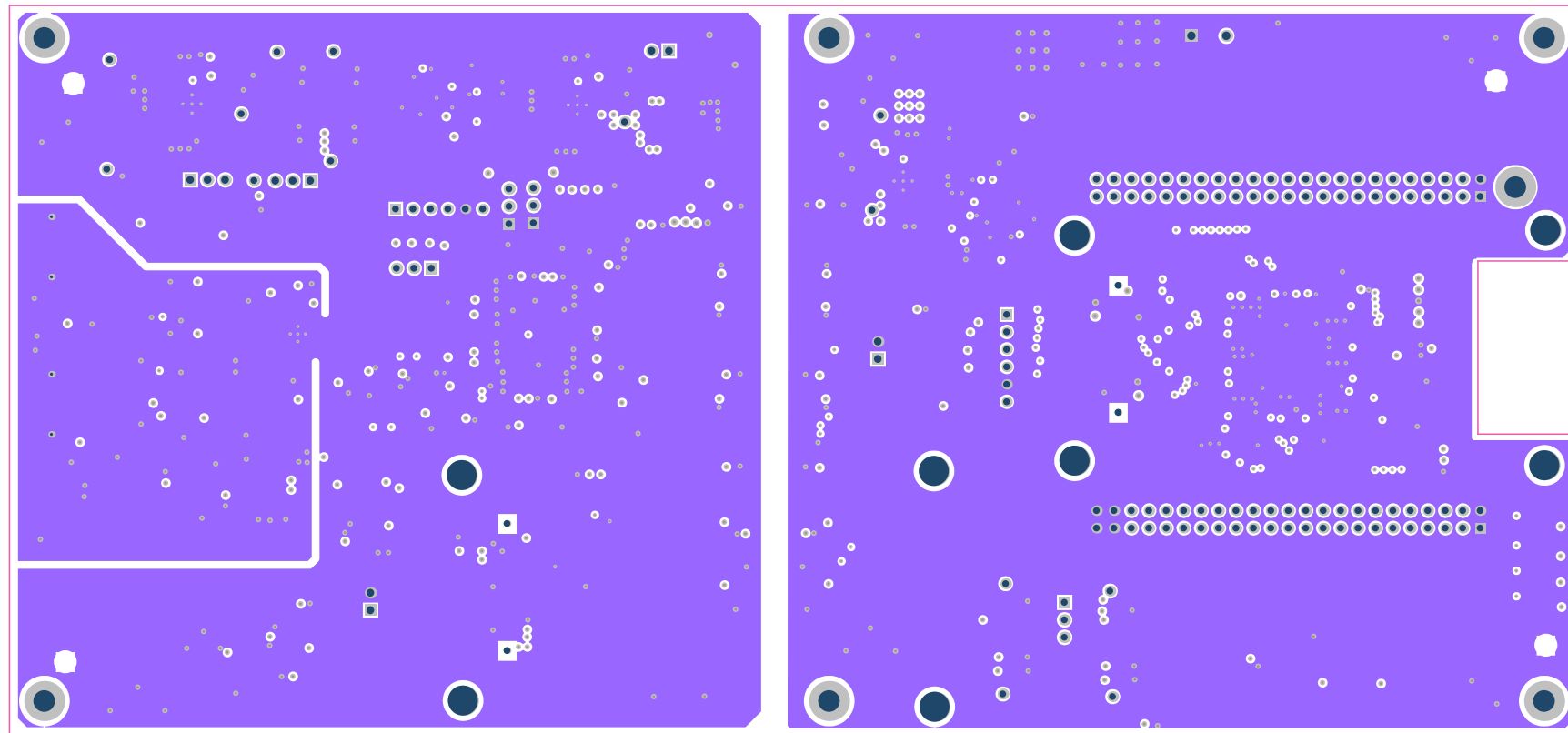
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = GND1	TID #: TIDA-00732		
PLOT NAME = GND1	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



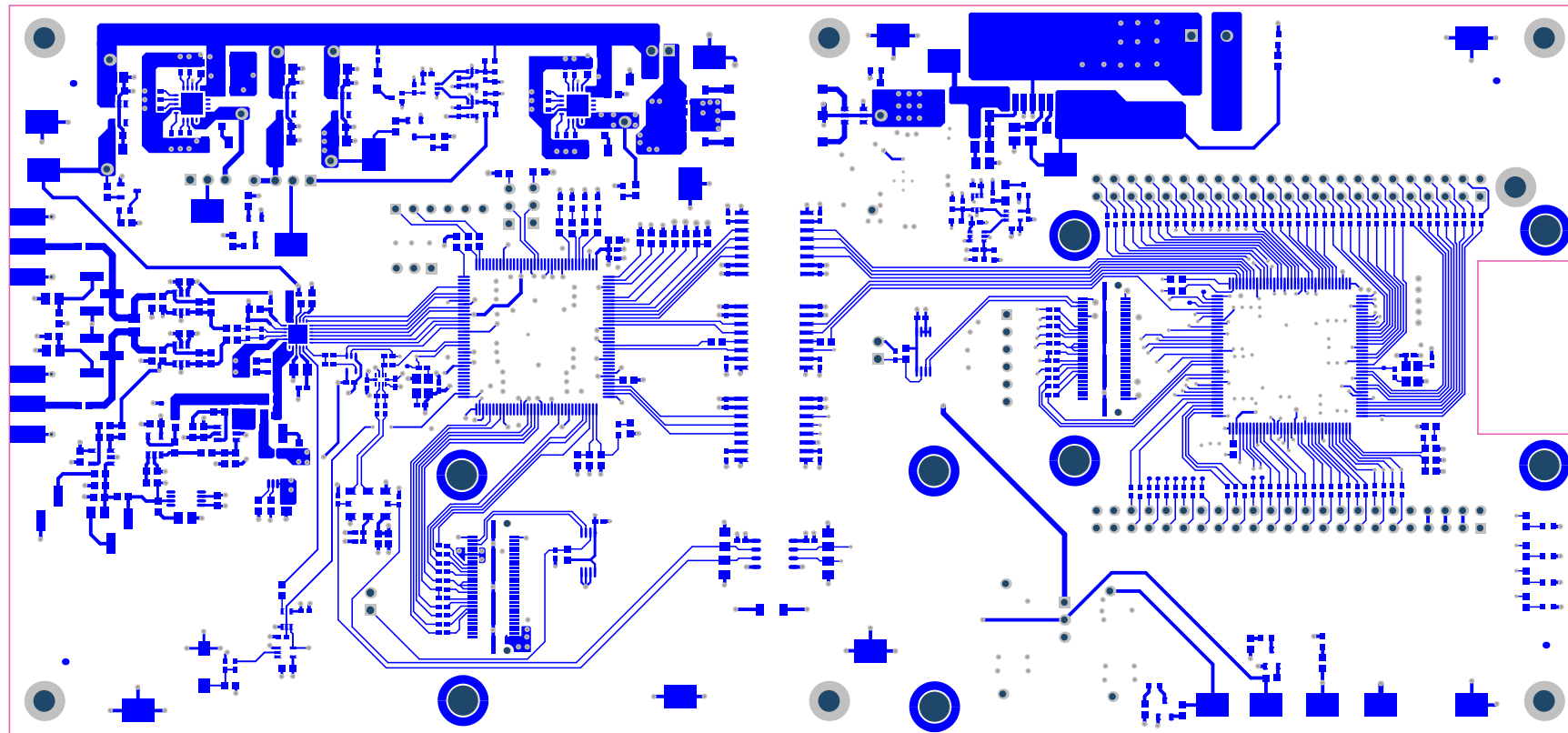
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = PWRI	TID #: TIDA-00732		
PLOT NAME = PWRI	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



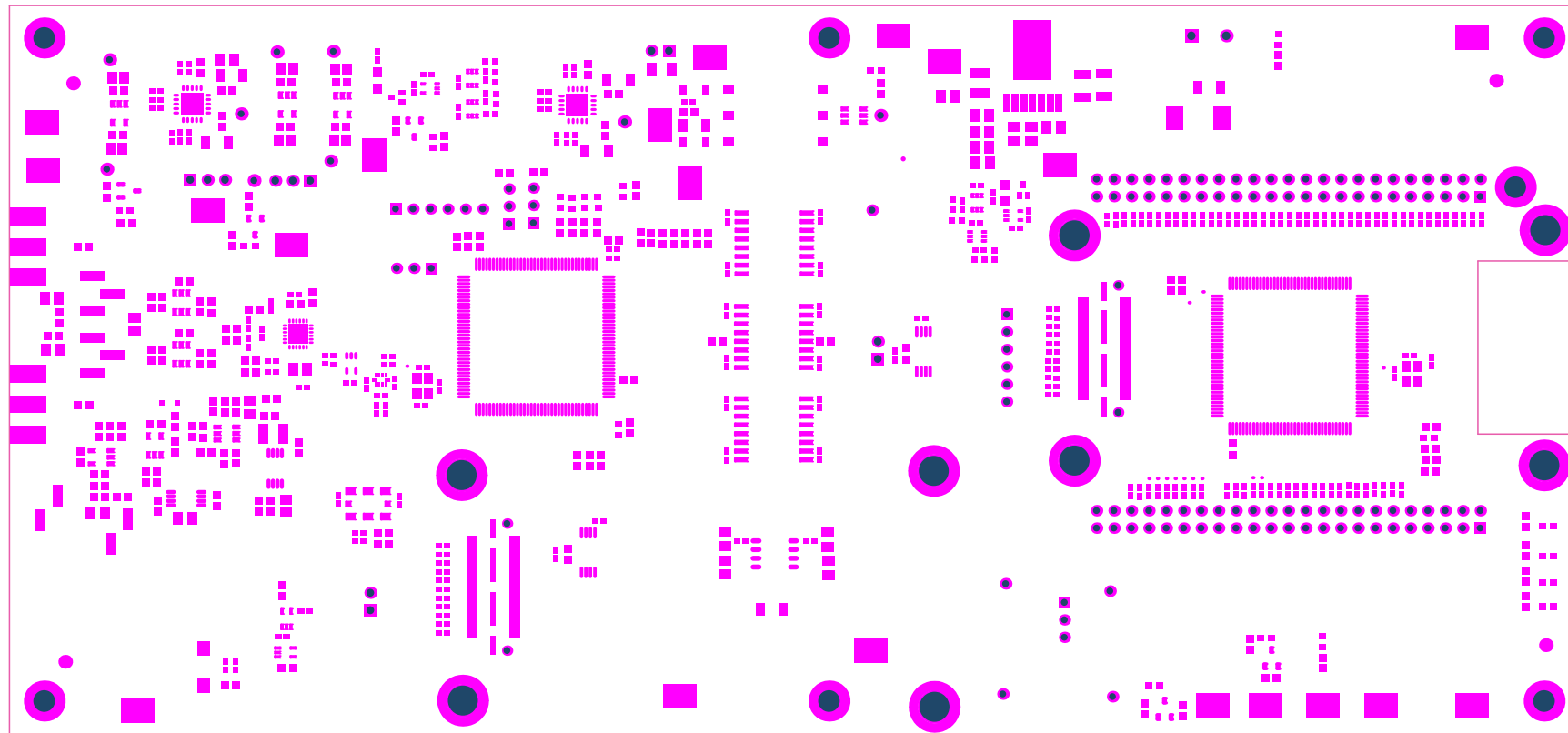
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = PWR2	TID #: TIDA-00732		
PLOT NAME = PWR2	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



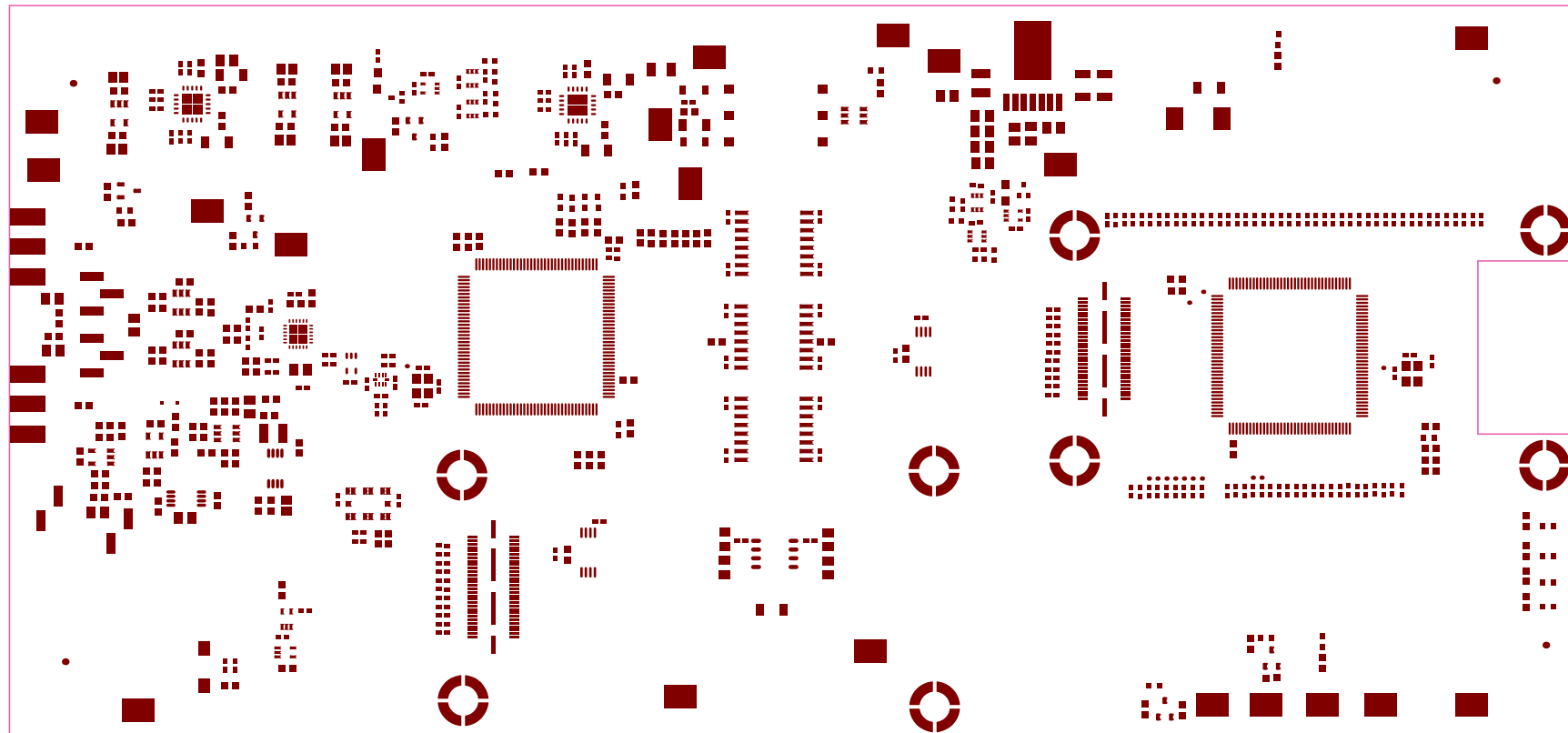
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = GND2	TID #: TIDA-00732		
PLOT NAME = GND2	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



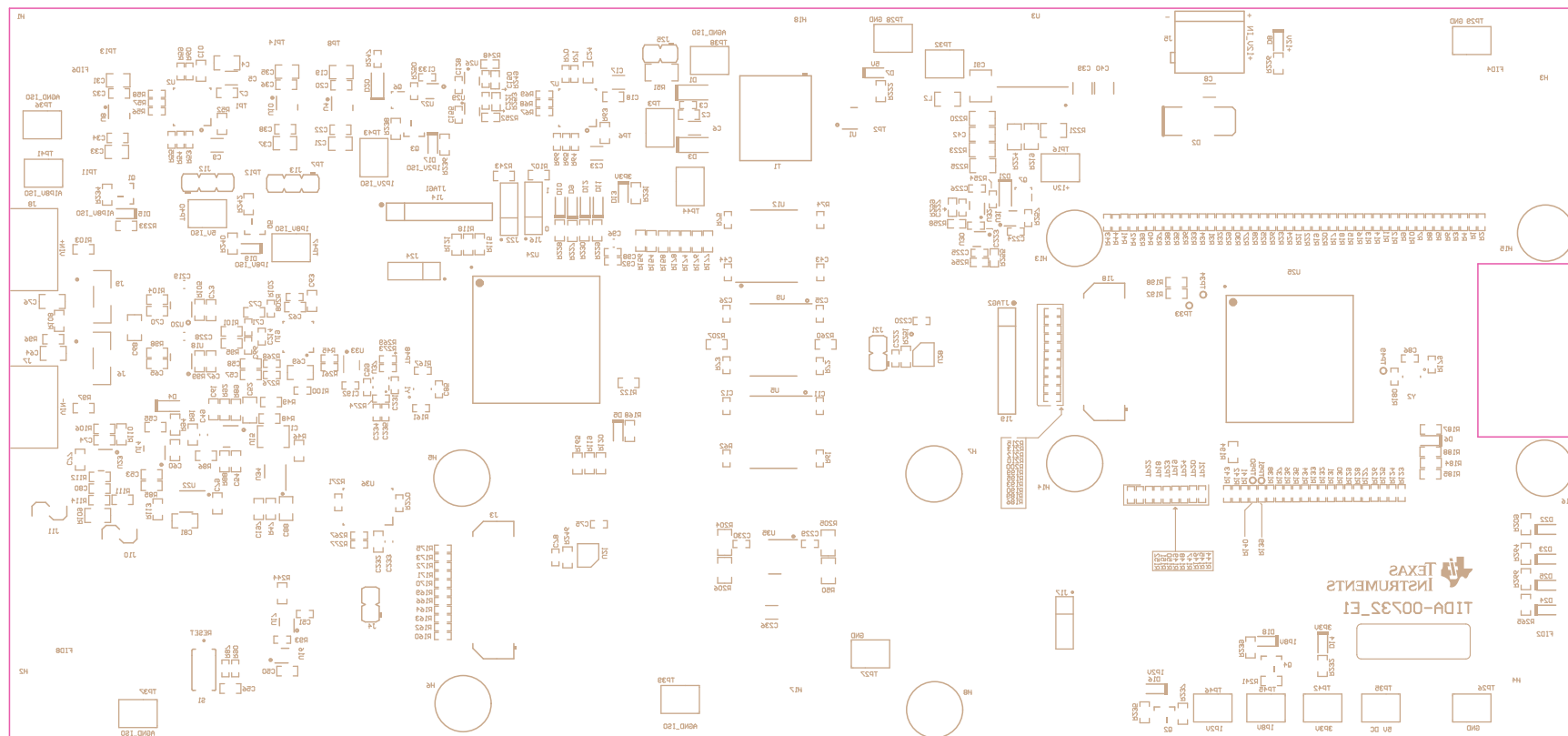
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = BOTTOM LAYER	TID #: TIDA-00732		
PLOT NAME = Bottom Layer	GENERATED : 02/10/2015 12:12:36 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = BOTTOM SOLDER	TID #: TIDA-00732		
PLOT NAME = Bottom Solder Mask	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = BOTTOM PASTE	TID #: TIDA-00732		
PLOT NAME = BOTTOM PASTE	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = BOTTOM OVERLAY	TID #: TIDA-00732		
PLOT NAME = Bottom Overlay	GENERATED : 02/10/2015 12:12:36 PM		TEXAS INSTRUMENTS

Symbol	Hit Count	Tool Size	Plated	Hole Type
D	20	7.874mil (0.2mm)	PTH	Round
B	175	12mil (0.305mm)	PTH	Round
A	402	16mil (0.406mm)	PTH	Round
G	4	18mil (0.457mm)	PTH	Round
C	19	20mil (0.508mm)	PTH	Round
H	4	40mil (1.016mm)	NPTH	Round
E	38	40mil (1.016mm)	PTH	Round
I	92	40.157mil (1.02mm)	PTH	Round
F	12	45.276mil (1.15mm)	PTH	Round
K	2	49.213mil (1.25mm)	PTH	Round
L	7	125mil (3.175mm)	PTH	Round
J	8	173.228mil (4.4mm)	NPTH	Round
783 Total				

Drill Table

FOR 7.874MIL DRILL +/-7.874MIL
FOR 12MIL DRILL +/-12MIL
FOR 16MIL DRILL +/-16MIL
FOR 18MIL DRILL +/-18MIL
FOR PTH DRILL +/-3MIL
FOR NPTH DRILL +/-2MIL



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME = DRILL DRAWING	TID #: TIDA-00732		
PLOT NAME = Drill Drawing	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00732	REV: E1	SUN REV:
LAYER NAME =	TID #: TIDA-00732		
PLOT NAME = Board Dimensions	GENERATED : 02/10/2015 12:12:36 PM	TEXAS INSTRUMENTS	

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